

Clock OSC

SG7050CCN

Product name SG7050CCN 11.059200 MHz HJGA

Product Number / Ordering code X1G0045010005xx

Please refer to the 8.Packing information about xx (last 2 digits)

Output waveform CMOS

Pb free / Complies with EU RoHS directive

Reference weight Typ. 147 mg

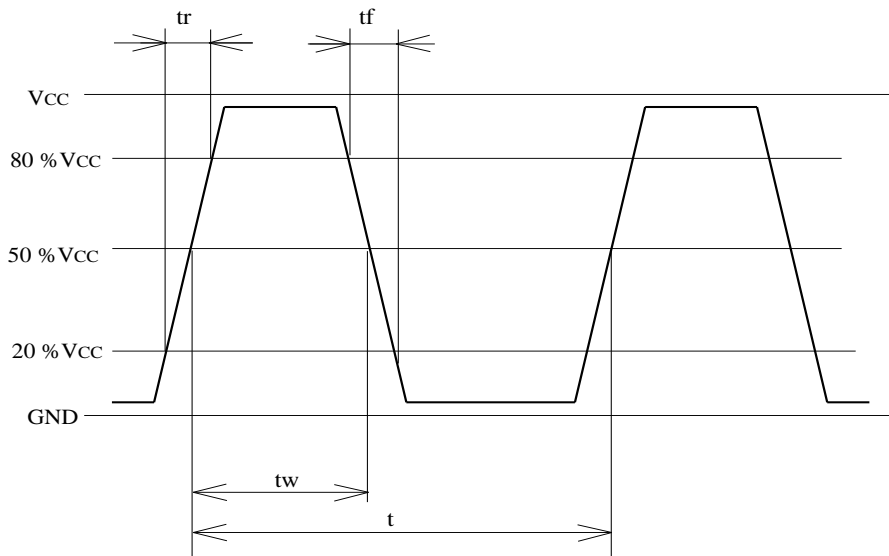
1.Absolute maximum ratings

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions / Remarks
Maximum supply voltage	V _{cc} -GND	-0.3	-	+7	V	-
Storage temperature	T _{stg}	-40	-	+125	°C	Storage as single product
Input voltage	V _{in}	-0.5	-	V _{cc} +0.5	V	OE terminal

2.Specifications(characteristics)

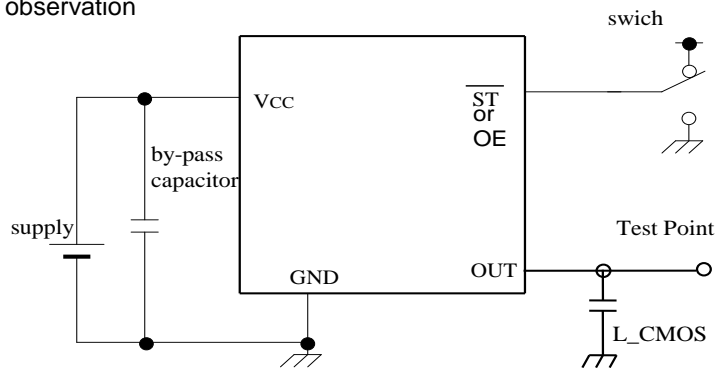
Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions / Remarks
Output frequency	f ₀		11.059200		MHz	
Supply voltage	V _{cc}	4.5	5	5.5	V	-
Operating temperature	T _{use}	-40	-	+85	°C	-
Frequency tolerance	f _{tol}	-50	-	50	x10 ⁻⁶	T _{use}
Current consumption	I _{cc}	-	-	20	mA	No load condition
Stand-by current	I _{std}	-	-	-	μA	-
Disable current	I _{dis}	-	-	10.0	mA	OE = GND
Symmetry	SYM	40	-	60	%	50% V _{cc} Level L _{CMOS} ≤50pF
Output voltage	V _{OH}	V _{cc} -0.4	-	-		-
	V _{OL}	-	-	0.4		-
Output load condition	L _{CMOS}	-	-	50	pF	CMOS Load
Input voltage	V _{IH}	0.8V _{cc}	-	-		OE terminal
	V _{IL}	-	-	0.2V _{cc}		OE terminal
Rise time	t _r	-	-	5	ns	0.2V _{cc} to 0.8V _{cc} Level, L _{CMOS} =50pF
Fall time	t _f	-	-	5	ns	0.2V _{cc} to 0.8V _{cc} Level, L _{CMOS} =50pF
Start-up time	t _{str}	-	-	5	ms	t = 0 at 0.9V _{cc}
Jitter	t _{DJ}	-	0	-	ps	Deterministic Jitter
	t _{RJ}	-	TBD	-	ps	Random Jitter
	t _{RMS}	-	TBD	-	ps	δ(RMS of total distribution)
	t _{p-p}	-	TBD	-	ps	Peak to Peak
	t _{acc}	-	-	-	ps	Accumulated Jitter(δ) n=2 to 50000 cycles
Phase jitter	t _{PJ}	-	TBD	-	ps	Off set Frequency: 12kHz to 20MHz
Phase noise	L(f)	-	-	-	dBc/Hz	Off set 1Hz
		-	TBD	-	dBc/Hz	Off set 10Hz
		-	TBD	-	dBc/Hz	Off set 100Hz V _{cc} =3.3V
		-	TBD	-	dBc/Hz	Off set 1kHz
		-	TBD	-	dBc/Hz	Off set 10kHz
		-	TBD	-	dBc/Hz	Off set 100kHz V _{cc} =3.3V
		-	TBD	-	dBc/Hz	Off set 1MHz
Frequency aging	f _{age}	-5	-	5	x10 ⁻⁶	@+25°C first year
		-	-	-		-

3. Timing chart

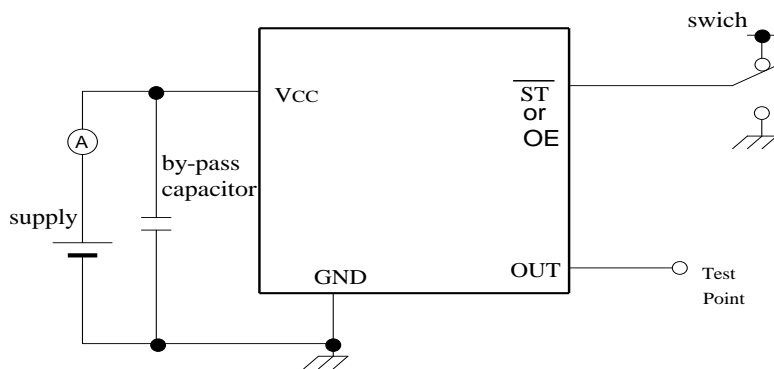


4. Test circuit

1) Waveform observation



2) Current consumption



*Current consumption under the disable function should be = GND.

3) Condition

(1) Oscilloscope

- Band width should be minimum 5 times higher (wider) than measurement frequency.
- Probe earth should be placed closely from test point and lead length should be as short as possible

* Recommendable to use miniature socket. (Don't use earth lead.)

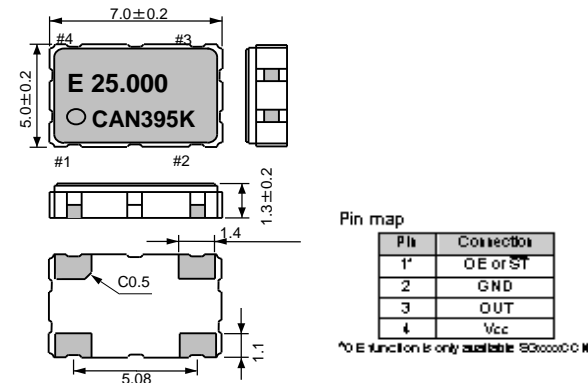
(2) L_CMOS also includes probe capacitance.

(3) By-pass capacitor (0.01 μ F to 0.1 μ F) is placed closely between VCC and GND.

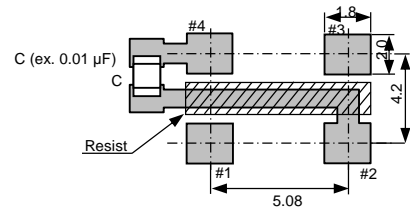
(4) Use the current meter whose internal impedance value is small.

(5) Power supply

- Start up time (0 %VCC to 90 %VCC) of power source should be more than 150 μ s.
- Impedance of power supply should be as lowest as possible.

5.External dimensions (Unit: mm)

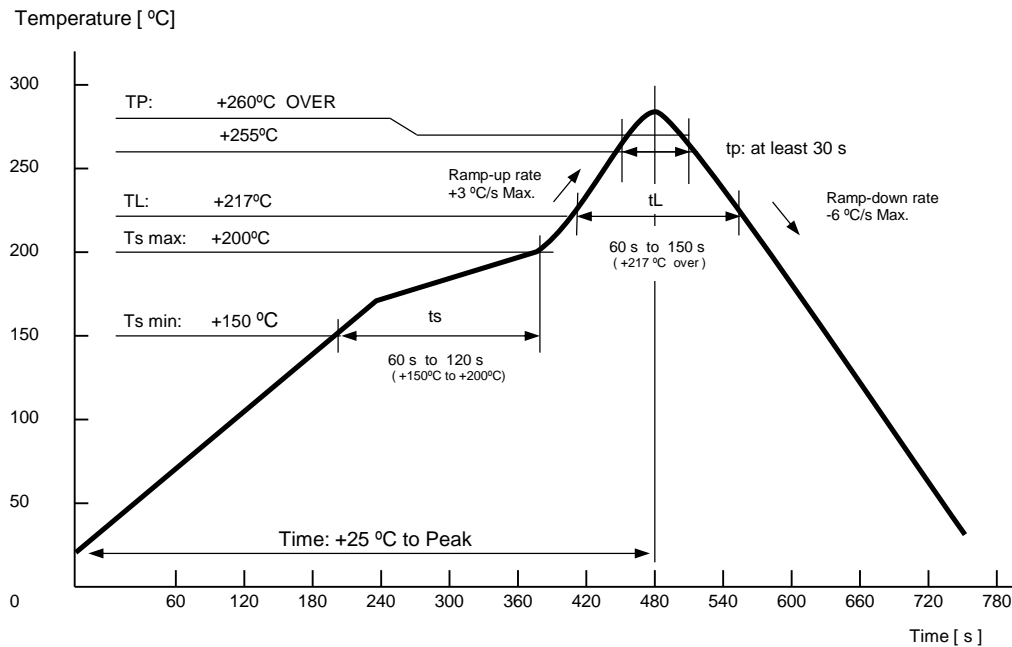
Note.
 OE pin = "H" or "open" : Specified frequency output.
 OE pin = "L" : Output is high impedance.
 ST pin = "H" or "open" : Specified frequency output.
 ST pin = "L" : Output is high impedance, oscillation stops.

6.Footprint(Recommended) (Unit: mm)

To maintain stable operation, provide a 0.01μF to 0.1μF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between V_{cc} - GND).

7.Reflow profile

Reflow condition (Follow of JEDEC STD-020D.1)

**8.Packing information**

[1]Product number last 2 digits code(xx) description

The recommended code is "00"

X1G0045010005xx

Code	Condition	Code	Condition
01	Any Q'ty vinyl bag(Tape cut)	13	500pcs / Reel
11	Any Q'ty / Reel	00	1000pcs / Reel
12	250pcs / Reel		

[2] Taping specification

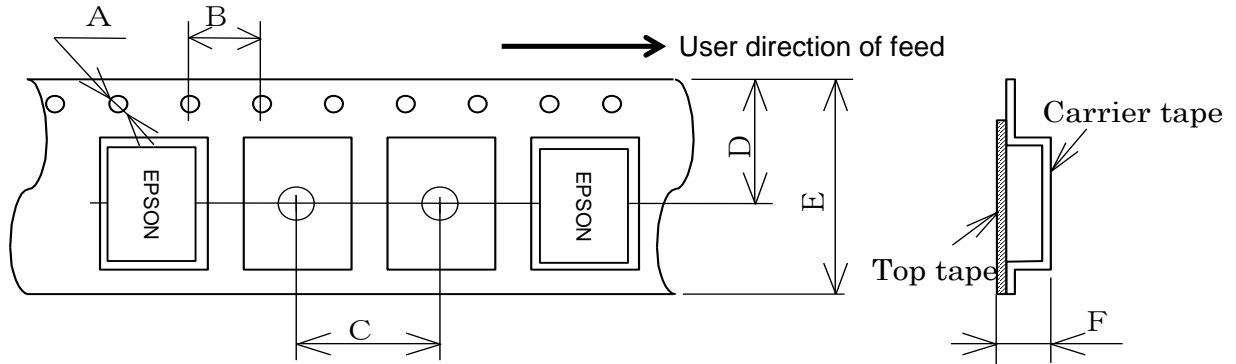
Subject to EIA-481 & IEC-60286

(1) Tape dimensions

Material of the Carrier Tape : PS

Material of the Top Tape : PET+PE

Unit: mm

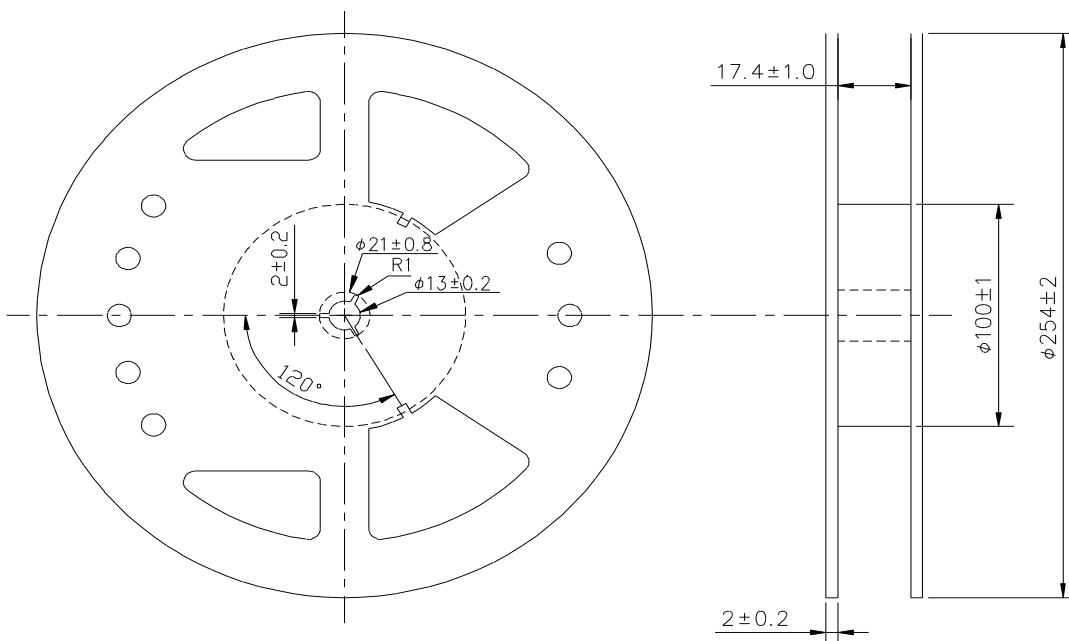


Symbol	A	B	C	D	E	F
Value	$\phi 1.5$	4	8	9.25	16	2.3

(2) Reel dimensions

Center material : PS

Material of the Reel : PS



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